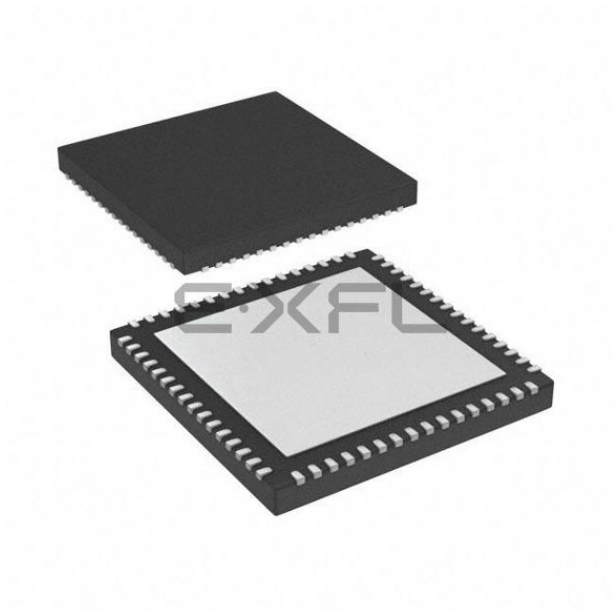

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LCD, POR, PWM, WDT
Number of I/O	59
Program Memory Size	56KB (32K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 45x12b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-VFQFN Exposed Pad
Supplier Device Package	64-QFN (9x9)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f19197-i-mr

TABLE 3: 64-PIN ALLOCATION TABLE (PIC16(L)F19195/6/7) (CONTINUED)

I/O(2)	64-Pin TQFP/QFN	ADC	Reference	Comparator	Zero-Cross Detect	DAC	Timers/SMT	CCP	PWM	CWG	MSSP	EUSART	CLC	RTCC	LCD	Interrupt-on-Change	High Current	Pull-up	Basic
RG7	19	ANG7	—	—	—	—	—	—	—	—	—	—	—	—	SEG15 COM7	—	—	Y	—
RH0	26	—	—	—	—	—	—	—	—	—	—	—	—	—	COM4	—	—	Y	—
RH1	25	ADCACT(1)	—	—	—	—	—	—	—	—	—	—	—	—	COM5	—	—	Y	—
RH2	57	—	—	—	—	—	—	—	—	—	—	—	—	—	SEG32 CFLY1	—	—	Y	—
RH3	56	—	—	—	—	—	—	—	—	—	—	—	—	—	SEG40 CFLY2	—	—	Y	—
VLCD3	64	—	—	—	—	—	—	—	—	—	—	—	—	—	VLCD3	—	—	—	—
VDD	10	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VDD
VDD	38	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VDD
VSS	9	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	V_{SS}
VSS	41	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VSS
OUT(2)	—	ADGRDA ADGRDB	—	C1OUT C2OUT	—	—	TMR0	CCP1 CCP2	PWM3 PWM4	CWG1A CWG1B CWG1C CWG1D	SDO SCK SCL SDA	TX1 DT1 CK1 TX2 DT2 CK2	CLC1OUT	RTCC	—	—	—	—	—

Note 1: This is a PPS remappable input signal. The input function may be moved from the default location shown to one of several other PORTx pins.

2: All digital output signals shown in this row are PPS remappable. These signals may be mapped to output onto one or more PORTx pin options.

3: This is a bidirectional signal. For normal module operation, the firmware should map this signal to the same pin in both the PPS input and PPS output registers.

4: These pins are configured for I^2C logic levels. PPS assignments to the other pins will operate, but input logic levels will be standard TTL/ST as selected by the INLVL register, instead of the I^2C specific or SMBUS input buffer thresholds.

5: These are alternative I^2C logic levels pins.

6: In I^2C logic levels configuration, these pins can operate as either SCL or SDA pins.

TABLE 4-12: SPECIAL FUNCTION REGISTER SUMMARY BANKS 0-63 PIC16(L)F19195/6/7 (CONTINUED)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on: MCLR
Bank 20											
CPU CORE REGISTERS; see Table 4-3 for specifics											
A0Ch	—	Unimplemented								---- ----	---- ----
A0Dh	—	Unimplemented								---- ----	---- ----
A0Eh	—	Unimplemented								---- ----	---- ----
A0Fh	—	Unimplemented								---- ----	---- ----
A10h	—	Unimplemented								---- ----	---- ----
A11h	—	Unimplemented								---- ----	---- ----
A12h	—	Unimplemented								---- ----	---- ----
A13h	—	Unimplemented								---- ----	---- ----
A14h	—	Unimplemented								---- ----	---- ----
A15h	—	Unimplemented								---- ----	---- ----
A16h	—	Unimplemented								---- ----	---- ----
A17h	—	Unimplemented								---- ----	---- ----
A18h	—	Unimplemented								---- ----	---- ----
A19h	RC2REG	RC2REG								0000 0000	0000 0000
A1Ah	TX2REG	TX2REG								0000 0000	0000 0000
A1Bh	SP2BRGL	SP2BRGL								0000 0000	0000 0000
A1Ch	SP2BRGH	SP2BRGH								0000 0000	0000 0000
A1Dh	RC2STA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 0000	0000 0000
A1Eh	TX2STA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	0000 0010	0000 0010
A1Fh	BAUD2CON	ABDOVF	RCIDL	—	SCKP	BRG16	—	WUE	ABDEN	01-0 0-00	01-0 0-00

Legend: x = unknown, u = unchanged, q = depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations unimplemented, read as '0'.

Note 1: Unimplemented data memory locations, read as '0'.

TABLE 4-12: SPECIAL FUNCTION REGISTER SUMMARY BANKS 0-63 PIC16(L)F19195/6/7 (CONTINUED)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on: MCLR
Bank 29											
CPU CORE REGISTERS; see Table 4-3 for specifics											
E8Ch	VB0GPR	VB0GPR								0000 0000	uuuu uuuu
E8Dh	VB1GPR	VB1GPR								0000 0000	uuuu uuuu
E8Eh	VB2GPR	VB2GPR								0000 0000	uuuu uuuu
E8Fh	VB3GPR	VB3GPR								0000 0000	uuuu uuuu
E90h	—	Unimplemented								---- ----	---- ----
E91h	—	Unimplemented								---- ----	---- ----
E92h	—	Unimplemented								---- ----	---- ----
E93h	—	Unimplemented								---- ----	---- ----
E94h	—	Unimplemented								---- ----	---- ----
E95h	—	Unimplemented								---- ----	---- ----
E96h	—	Unimplemented								---- ----	---- ----
E97h	—	Unimplemented								---- ----	---- ----
E98h	—	Unimplemented								---- ----	---- ----
E99h	—	Unimplemented								---- ----	---- ----
E9Ah	—	Unimplemented								---- ----	---- ----
E9Bh	—	Unimplemented								---- ----	---- ----
E9Ch	—	Unimplemented								---- ----	---- ----
E9Dh	—	Unimplemented								---- ----	---- ----
E9Eh	—	Unimplemented								---- ----	---- ----
E9Fh	—	Unimplemented								---- ----	---- ----

Legend: x = unknown, u = unchanged, q = depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations unimplemented, read as '0'.

Note 1: Unimplemented data memory locations, read as '0'.

To minimize current consumption, the following conditions should be considered:

- I/O pins should not be floating
- External circuitry sinking current from I/O pins
- Internal circuitry sourcing current from I/O pins
- Current draw from pins with internal weak pull-ups
- Modules using any oscillator

I/O pins that are high-impedance inputs should be pulled to VDD or VSS externally to avoid switching currents caused by floating inputs.

Any module with a clock source that is not FOSC can be enabled. Examples of internal circuitry that might be sourcing current include modules such as the DAC and FVR modules. See **Section 21.0 "5-Bit Digital-to-Analog Converter (DAC1) Module"**, **Section 18.0 "Fixed Voltage Reference (FVR)"** for more information on these modules.

11.2.1 WAKE-UP FROM SLEEP

The device can wake-up from Sleep through one of the following events:

1. External Reset input on $\overline{\text{MCLR}}$ pin, if enabled.
2. BOR Reset, if enabled.
3. POR Reset.
4. Watchdog Timer, if enabled.
5. Any external interrupt.
6. Interrupts by peripherals capable of running during Sleep (see individual peripheral for more information).

The first three events will cause a device Reset. The last three events are considered a continuation of program execution. To determine whether a device Reset or wake-up event occurred, refer to **Section 8.14 "Determining the Cause of a Reset"**.

When the SLEEP instruction is being executed, the next instruction (PC + 1) is prefetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be enabled. Wake-up will occur regardless of the state of the GIE bit. If the GIE bit is disabled, the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is enabled, the device executes the instruction after the SLEEP instruction, the device will then call the Interrupt Service Routine. In cases where the execution of the instruction following SLEEP is not desirable, the user should have a NOP after the SLEEP instruction.

The WWDT is cleared when the device wakes-up from Sleep, regardless of the source of wake-up.

TABLE 14-3: SUMMARY OF REGISTERS ASSOCIATED WITH PORTB

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	212
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	212
LATB	LATB7	LATB6	LATB5	LATB4	LATB3	LATB2	LATB1	LATB0	213
ANSELB	ANSB7	ANSB6	ANSB5	ANSB4	ANSB3	ANSB2	ANSB1	ANSB0	213
WPUB	WPUB7	WPUB6	WPUB5	WPUB4	WPUB3	WPUB2	WPUB1	WPUB0	214
ODCONB	ODCB7	ODCB6	ODCB5	ODCB4	ODCB3	ODCB2	ODCB1	ODCB0	214
SLRCONB	SLRB7	SLRB6	SLRB5	SLRB4	SLRB3	SLRB2	SLRB1	SLRB0	215
INLVLB	INLVLB7	INLVLB6	INLVLB5	INLVLB4	INLVLB3	INLVLB2	INLVLB1	INLVLB0	215

Legend: x = unknown, u = unchanged, – = unimplemented locations read as '0'. Shaded cells are not used by PORTB.

14.10 PORTE Registers

14.10.1 DATA REGISTER

PORTE is an 8-bit wide, bidirectional port. The corresponding data direction register is TRISE (Register 14-2). Setting a TRISE bit (= 1) will make the corresponding PORTE pin an input (i.e., disable the output driver). Clearing a TRISE bit (= 0) will make the corresponding PORTE pin an output (i.e., enables output driver and puts the contents of the output latch on the selected pin). Example 14.2.8 shows how to initialize PORTE.

Reading the PORTE register (Register 14-1) reads the status of the pins, whereas writing to it will write to the PORT latch.

The PORT data latch LATE (Register 14-3) holds the output port data, and contains the latest value of a LATE or PORTE write.

EXAMPLE 14-4: INITIALIZING PORTE

```
; This code example illustrates
; initializing the PORTE register. The
; other ports are initialized in the same
; manner.

BANKSEL  PORTE        ;
CLRF     PORTE        ;Init PORTE
BANKSEL  LATE         ;Data Latch
CLRF     LATE         ;
BANKSEL  ANSELE       ;
CLRF     ANSELE       ;digital I/O
BANKSEL  TRISE        ;
MOVLW    B'00111000'  ;Set RE<5:3> as inputs
MOVWF    TRISE        ;and set RE<2:0> as
                      ;outputs
```

14.10.2 DIRECTION CONTROL

The TRISE register (Register 14-2) controls the PORTE pin output drivers, even when they are being used as analog inputs. The user should ensure the bits in the TRISE register are maintained set when using them as analog inputs. I/O pins configured as analog inputs always read '0'.

14.10.3 OPEN-DRAIN CONTROL

The ODCONE register (Register 14-6) controls the open-drain feature of the port. Open-drain operation is independently selected for each pin. When an ODCONE bit is set, the corresponding port output becomes an open-drain driver capable of sinking current only. When an ODCONE bit is cleared, the corresponding port output pin is the standard push-pull drive capable of sourcing and sinking current.

Note:	It is not necessary to set open-drain control when using the pin for I^2C; the I^2C module controls the pin and makes the pin open-drain.

14.10.4 SLEW RATE CONTROL

The SLRCONE register (Register 14-7) controls the slew rate option for each port pin. Slew rate control is independently selectable for each port pin. When an SLRCONE bit is set, the corresponding port pin drive is slew rate limited. When an SLRCONE bit is cleared, The corresponding port pin drive slews at the maximum rate possible.

14.10.5 INPUT THRESHOLD CONTROL

The INLVLE register (Register 14-8) controls the input voltage threshold for each of the available PORTE input pins. A selection between the Schmitt Trigger CMOS or the TTL Compatible thresholds is available. The input threshold is important in determining the value of a read of the PORTE register and also the level at which an interrupt-on-change occurs, if that feature is enabled. See Table 39-4 for more information on threshold levels.

Note:	Changing the input threshold selection should be performed while all peripheral modules are disabled. Changing the threshold level during the time a module is active may inadvertently generate a transition associated with an input pin, regardless of the actual voltage level on that pin.

14.16.6 ANALOG CONTROL

The ANSELH register (Register 14-4) is used to configure the Input mode of an I/O pin to analog. Setting the appropriate ANSELH bit high will cause all digital reads on the pin to be read as '0' and allow analog functions on the pin to operate correctly.

The state of the ANSELH bits has no effect on digital output functions. A pin with its TRIS bit clear and its ANSEL bit set will still operate as a digital output, but the Input mode will be analog. This can cause unexpected behavior when executing read-modify-write instructions on the affected port.

Note:	The ANSELH bits default to the Analog mode after Reset. To use any pins as digital general purpose or peripheral inputs, the corresponding ANSEL bits must be initialized to '0' by user software.

14.16.7 WEAK PULL-UP CONTROL

The WPUH register (Register 14-5) controls the individual weak pull-ups for each PORT pin.

14.16.8 PORTH FUNCTIONS AND OUTPUT PRIORITIES

Each PORTH pin is multiplexed with other functions.

Each pin defaults to the PORT latch data after Reset. Other output functions are selected with the peripheral pin select logic or by enabling an analog output, such as the DAC. See **Section 15.0 "Peripheral Pin Select (PPS) Module"** for more information.

Analog input functions, such as ADC and comparator inputs are not shown in the peripheral pin select lists. Digital output functions may continue to control the pin when it is in Analog mode.

REGISTER 17-7: IOCEP: INTERRUPT-ON-CHANGE PORTE POSITIVE EDGE REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
IOCEP7	IOCEP6	IOCEP5	IOCEP4	IOCEP3	IOCEP2	IOCEP1	IOCEP0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **IOCEP<7:0>:** Interrupt-on-Change PORTE Positive Edge Enable bits
1 = Interrupt-on-Change enabled on the pin for a positive-going edge. IOCEFx bit and IOCIF flag will be set upon detecting an edge.
0 = Interrupt-on-Change disabled for the associated pin

REGISTER 17-8: IOCEN: INTERRUPT-ON-CHANGE PORTC NEGATIVE EDGE REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
IOCEN7	IOCEN6	IOCEN5	IOCEN4	IOCEN3	IOCEN2	IOCEN1	IOCEN0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **IOCEN<7:0>:** Interrupt-on-Change PORTE Negative Edge Enable bits
1 = Interrupt-on-Change enabled on the pin for a negative-going edge. IOCEFx bit and IOCIF flag will be set upon detecting an edge.
0 = Interrupt-on-Change disabled for the associated pin

REGISTER 17-9: IOCEF: INTERRUPT-ON-CHANGE PORTE FLAG REGISTER

R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0
IOCEF7	IOCEF6	IOCEF5	IOCEF4	IOCEF3	IOCEF2	IOCEF1	IOCEF0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HS - Bit is set in hardware

bit 7-0 **IOCEF<7:0>:** Interrupt-on-Change PORTE Flag bits
1 = An enabled change was detected on the associated pin
Set when IOCEPx = 1 and a rising edge was detected on REx, or when IOCENx = 1 and a falling edge was detected on REx.
0 = No change was detected, or the user cleared the detected change

19.2 ADC Operation

19.2.1 STARTING A CONVERSION

To enable the ADC module, the ON bit of the ADCON0 register must be set to a '1'. A conversion may be started by any of the following:

- Software setting the GO bit of ADCON0 to '1'
- An external trigger (selected by Register 19-3)
- A continuous-mode retrigger (see section **Section 19.5.8 "Continuous Sampling mode"**)

Note:	The GO bit should not be set in the same instruction that turns on the ADC. Refer to **Section 19.2.6 "ADC Conversion Procedure (Basic Mode)"**.

19.2.2 COMPLETION OF A CONVERSION

When any individual conversion is complete, the value already in ADRES is written into PREV (if ADPSIS = 1) and the new conversion results appear in ADRES. When the conversion completes, the ADC module will:

- Clear the GO bit (unless the CONT bit of ADCON0 is set)
- Set the ADIF Interrupt Flag bit
- Set the ADMATH bit
- Update ACC

When ADDSEN = 0 then after every conversion, or when ADDSEN = 1 then after every other conversion, the following events occur:

- ERR is calculated
- ADTIF is set if ERR calculation meets threshold comparison

Importantly, filter and threshold computations occur after the conversion itself is complete. As such, interrupt handlers responding to ADIF should check ADTIF before reading filter and threshold results.

Note:	A device Reset forces all registers to their Reset state. Thus, the ADC module is turned off and any pending conversion is terminated.

19.2.3 ADC OPERATION DURING SLEEP

The ADC module can operate during Sleep. This requires the ADC clock source to be set to the ADCRC option. When the FRC oscillator source is selected, the ADC waits one additional instruction before starting the conversion. This allows the SLEEP instruction to be executed, which can reduce system noise during the conversion. If the ADC interrupt is enabled, the device will wake-up from Sleep when the conversion completes. If the ADC interrupt is disabled, the ADC module is turned off after the conversion completes, although the ON bit remains set.

19.2.4 EXTERNAL TRIGGER DURING SLEEP

If the external trigger is received during sleep while ADC clock source is set to the FRC, ADC module will perform the conversion and set the ADIF bit upon completion.

If an external trigger is received when the ADC clock source is something other than FRC, the trigger will be recorded, but the conversion will not begin until the device exits Sleep.

21.6 Register Definitions: DAC Control

REGISTER 21-1: DAC1CON0: VOLTAGE REFERENCE CONTROL REGISTER 0

R/W-0/0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	U-0	U-0
DAC1EN	—	DAC1OE1	DAC1OE2	DAC1PSS<1:0>		—	—
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7 **DAC1EN:** DAC1 Enable bit
1 = DAC is enabled
0 = DAC is disabled

bit 6 **Unimplemented:** Read as ‘0’

bit 5 **DAC1OE1:** DAC1 Voltage Output 1 Enable bit
1 = DAC voltage level is an output on the DAC1OUT1 pin
0 = DAC voltage level is disconnected from the DAC1OUT1 pin

bit 4 **DAC1OE2:** DAC1 Voltage Output 1 Enable bit
1 = DAC voltage level is an output on the DAC1OUT2 pin
0 = DAC voltage level is disconnected from the DAC1OUT2 pin

bit 3-2 **DAC1PSS<1:0>:** DAC1 Positive Source Select bits
11 = Reserved, do not use
10 = FVR output
01 = V_{REF+} pin
00 = V_{DD}

bit 1-0 **Unimplemented:** Read as ‘0’

REGISTER 21-2: DAC1CON1: VOLTAGE REFERENCE CONTROL REGISTER 1

U-0	U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—	—	—	DAC1R<4:0>				
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-5 **Unimplemented:** Read as ‘0’

bit 4-0 **DAC1R<4:0>:** DAC1 Voltage Output Select bits
$V_{OUT} = (V_{SRC+} - V_{SRC-})*(DAC1R<4:0>/32) + V_{SRC-}$

22.0 COMPARATOR MODULE

Comparators are used to interface analog circuits to a digital circuit by comparing two analog voltages and providing a digital indication of their relative magnitudes. Comparators are very useful mixed signal building blocks because they provide analog functionality independent of program execution. The analog comparator module includes the following features:

- Programmable input selection
- Selectable voltage reference
- Programmable output polarity
- Rising/falling output edge interrupts
- Programmable Speed/Power optimization
- CWG1 Auto-shutdown source

22.1 Comparator Overview

A single comparator is shown in Figure 22-1 along with the relationship between the analog input levels and the digital output. When the analog voltage at VIN+ is less than the analog voltage at VIN-, the output of the comparator is a digital low level. When the analog voltage at VIN+ is greater than the analog voltage at VIN-, the output of the comparator is a digital high level.

The comparators available are shown in Table 22-1.

TABLE 22-1: AVAILABLE COMPARATORS

Device	C1	C2
PIC16(L)F19195/6/7	•	•

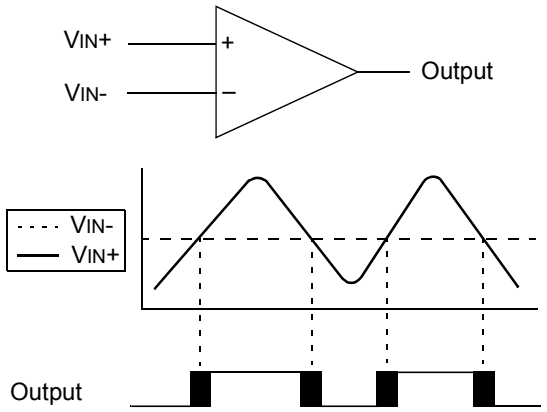
22.2 C2 Low-Power Clocked Comparator

C2 is a low-power LFINTOSC clocked comparator. On each rising edge of LFINTOSC the output state of the comparator is updated based on the states of the comparator inputs.

22.2.1 LOW POWER REFERENCE

C2 has access to a low power reference source (3.072V) used by the LCD module. If the lowest power operation is desired and a highest variation tolerance is acceptable, the user can choose the C2 Low-Power Clocked Comparator with the LCD VREF as a positive channel input (see Comparator Positive Input Channel Select bits PCH<2:0>). See **Section 18.0 "Fixed Voltage Reference (FVR)"** for additional details.

FIGURE 22-1: SINGLE COMPARATOR



Note: The black areas of the output of the comparator represents the uncertainty due to input offsets and response time.

22.4 Comparator Hysteresis

A selectable amount of separation voltage can be added to the input pins of each comparator to provide a hysteresis function to the overall operation. Hysteresis is enabled by setting the CxHYS bit of the CMxCON0 register.

See Comparator Specifications in Table 39-14 for more information.

22.5 Timer1 Gate Operation

The output resulting from a comparator operation can be used as a source for gate control of Timer1. See **Section 26.6 "Timer Gate"** for more information. This feature is useful for timing the duration or interval of an analog event.

It is recommended that the comparator output be synchronized to Timer1 by setting CMxCON0.SYNC = 1.

22.5.1 COMPARATOR OUTPUT SYNCHRONIZATION

The output from a comparator can be synchronized with Timer1 by setting the CxSYNC bit of the CMxCON0 register.

Once enabled, the comparator output is latched on the falling edge of the Timer1 source clock. If a prescaler is used with Timer1, the comparator output is latched after the prescaling function. To prevent a race condition, the comparator output is latched on the falling edge of the Timer1 clock source and Timer1 increments on the rising edge of its clock source. See the Comparator Block Diagram (Figure 22-2) and the Timer1 Block Diagram (Figure 26-1) for more information.

22.6 Comparator Interrupt

An interrupt can be generated upon a change in the output value of the comparator for each comparator, a rising edge detector and a falling edge detector are present.

When either edge detector is triggered and its associated enable bit is set (CxINTP and/or CxINTN bits of the CMxCON1 register), the Corresponding Interrupt Flag bit (CxIF bit of the PIR2 register) will be set.

To enable the interrupt, you must set the following bits:

- CxON, CxPOL and CxSP bits of the CMxCON0 register
- CxIE bit of the PIE2 register
- CxINTP bit of the CMxCON1 register (for a rising edge detection)
- CxINTN bit of the CMxCON1 register (for a falling edge detection)
- PEIE and GIE bits of the INTCON register

The associated interrupt flag bit, CxIF bit of the PIR2 register, must be cleared in software. If another edge is detected while this flag is being cleared, the flag will still be set at the end of the sequence.

Note:	Although a comparator is disabled, an interrupt can be generated by changing the output polarity with the CxPOL bit of the CMxCON0 register, or by switching the comparator on or off with the CxON bit of the CMxCON0 register.

22.7 Comparator Positive Input Selection

Configuring the CxPCH<2:0> bits of the CMxPSEL register directs an internal voltage reference or an analog pin to the noninverting input of the comparator:

- CxIN0+ analog pin
- DAC output
- FVR (Fixed Voltage Reference)
- VSS (Ground)

See **Section 18.0 "Fixed Voltage Reference (FVR)"** for more information on the Fixed Voltage Reference module.

See **Section 21.0 "5-Bit Digital-to-Analog Converter (DAC1) Module"** for more information on the DAC input signal.

Any time the comparator is disabled (CxON = 0), all comparator inputs are disabled.

22.8 Comparator Negative Input Selection

The CxNCH<2:0> bits of the CMxCON1 register direct an analog input pin and internal reference voltage or analog ground to the inverting input of the comparator:

- CxIN- pin
- FVR (Fixed Voltage Reference)
- Analog Ground

Note:	To use CxINy+ and CxINy- pins as analog input, the appropriate bits must be set in the ANSEL register and the corresponding TRIS bits must also be set to disable the output drivers.

23.2 ZCD Logic Output

The ZCD module includes a Status bit, which can be read to determine whether the current source or sink is active. The OUT bit of the ZCDxCON register is set when the current sink is active, and cleared when the current source is active. The OUT bit is affected by the polarity even if the module is disabled.

23.3 ZCD Logic Polarity

The POL bit of the ZCDxCON register inverts the ZCDxOUT bit relative to the current source and sink output. When the POL bit is set, a OUT high indicates that the current source is active, and a low output indicates that the current sink is active.

The POL bit affects the ZCD interrupts. See **Section 23.4 "ZCD Interrupts"**.

23.4 ZCD Interrupts

An interrupt will be generated upon a change in the ZCD logic output when the appropriate interrupt enables are set. A rising edge detector and a falling edge detector are present in the ZCD for this purpose.

The ZCDIF bit of the PIR2 register will be set when either edge detector is triggered and its associated enable bit is set. The INTP enables rising edge interrupts and the INTN bit enables falling edge interrupts. Both are located in the ZCDxCON register.

To fully enable the interrupt, the following bits must be set:

- ZCDIE bit of the PIE2 register
- INTP bit of the ZCDxCON register (for a rising edge detection)
- INTN bit of the ZCDxCON register (for a falling edge detection)
- PEIE and GIE bits of the INTCON register

Changing the POL bit can cause an interrupt, regardless of the level of the EN bit.

The ZCDIF bit of the PIR2 register must be cleared in software as part of the interrupt service. If another edge is detected while this flag is being cleared, the flag will still be set at the end of the sequence.

23.5 Correcting for V_{CPINV} offset

The actual voltage at which the ZCD switches is the reference voltage at the noninverting input of the ZCD op amp. For external voltage source waveforms other than square waves, this voltage offset from zero causes the zero-cross event to occur either too early or too late.

23.5.1 CORRECTION BY AC COUPLING

When the external voltage source is sinusoidal then the effects of the V_{CPINV} offset can be eliminated by isolating the external voltage source from the ZCD pin with a capacitor in addition to the voltage reducing resistor. The capacitor will cause a phase shift resulting in the ZCD output switch in advance of the actual zero-crossing event. The phase shift will be the same for both rising and falling zero crossings, which can be compensated for by either delaying the CPU response to the ZCD switch by a timer or other means, or selecting a capacitor value large enough that the phase shift is negligible.

To determine the series resistor and capacitor values for this configuration, start by computing the impedance, Z, to obtain a peak current of 300 uA. Next, arbitrarily select a suitably large non-polar capacitor and compute its reactance, Xc, at the external voltage source frequency. Finally, compute the series resistor, capacitor peak voltage, and phase shift by the formulas shown in Equation 23-2.

24.1 OPERATION

The RTCC consists of a 100-year clock and calendar with automatic leap year detection. The range of the clock is from 00:00:00 (midnight) on January 1st, 2000 to 23:59:59 on December 31st, 2099.

The hours use the 24-hour time format (military time) with no hardware provisions for regular time format (AM/PM). The clock provides a granularity of one second with additional visibility to the half-second.

The user has visibility to the half second field of the counter. This value is read-only and can be reset only by writing to the lower half of the SECONDS register.

24.1.1 REGISTER INTERFACE

The RTCC register set is divided into the following categories:

Control Registers

- RTCCON
- RTCCAL
- ALRMCON
- ALRMRPT

Clock Value Registers

- YEAR
- MONTH
- DAY
- WEEKDAY
- HOURS
- MINUTES
- SECONDS

Alarm Value Registers

- ALRMMNTH
- ALRMDAY
- ALRMWD
- ALRMHR
- ALRMMIN
- ALRMSEC

Note:	The WEEKDAY register is not automatically derived from the date, but it must be correctly set by the user.

The register interface for the RTCC and alarm values is implemented using the Binary Coded Decimal (BCD) format. This simplifies the firmware when using the module, as each of the digits is contained within its own 4-bit value (see Figure 24.1.3 and Figure 24-3).

All timer registers containing a value of seconds or greater are writable. The user can configure the initial start date and time by writing the year, month, day, hour, minutes and seconds into the clock value registers and the timer will then proceed to count from the newly written values.

The RTCC module is enabled by setting the RTCEN bit (RTCCON<7>). Once the RTCC is enabled, the timer will continue incrementing, even while the clock value registers are being re-written. However, any time the SECONDS register is written to, all of the clock value prescalers are reset to '0'. This allows lower granularity of timer adjustments.

The Timer registers are updated in the same cycle as the write instruction's execution by the CPU. The user must ensure that when RTCEN = 1, the updated registers will not be incremented at the same time. This can be accomplished in several ways:

- By checking the RTCSYNC bit (RTCCON<4>)
- By checking the preceding digits from which a carry can occur
- By updating the registers immediately following the seconds pulse (or alarm interrupt)

24.1.2 WRITE LOCK

To perform a write to any of the RTCC timer registers, the RTCWREN bit must be set. To avoid accidental writes to the timer, it is recommended that the RTCWREN bit is kept clear at any other time.

The RTCEN bit can only be written to when RTCWREN = 1. A write attempt to this bit while RTCWREN = 0 will be ignored. The RTCC timer registers can be written with RTCEN = 0 or 1.

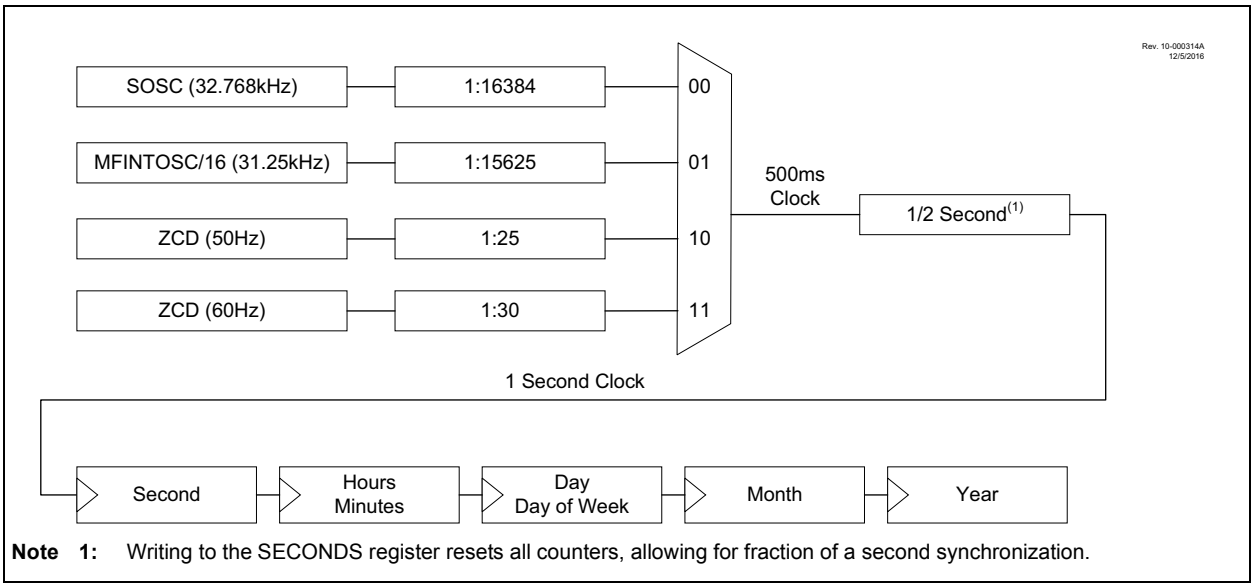
24.1.3 CLOCK SOURCES

The RTCC module can be clocked by either an external Real-Time Clock crystal oscillating at 32.768 kHz, MFINTOSC/16 (31.25 kHz) or via the ZCD at 50 Hz or 60 Hz. Each clock selection has a fix prescaler in order to generate the required 1/2 clock needed by the RTCC. They are as following:

- SOSC (32.768 kHz) = 1:16384
- MFINTOSC/16 (31.25 kHz) = 1:15625
- ZCD (50 Hz) = 1:25
- ZCD (60 Hz) = 1:30

Calibration of the RTCC can be performed to yield an error of three seconds or less per month (see **Section 24.1.7 "Calibration"** for further details).

FIGURE 24-4: CLOCK SOURCE MULTIPLEXING



Note 1: Writing to the SECONDS register resets all counters, allowing for fraction of a second synchronization.

24.1.4 DIGIT CARRY RULES

This section explains which timer values are affected when there is a rollover.

- Time of Day: From 23:59:59 to 00:00:00 with a carry to the Day and Weekday field
- Month: From 12/31 to 01/01 with a carry to the Year field
- Day of Week: From 6 to 0 with no carry (see Table 24-1)
- Year Carry: From 99 to 00; this also surpasses the use of the RTCC

For the day to month rollover schedule, see Table 24-2.

Because the following values are in BCD format, the carry to the upper BCD digit will occur at a count of 10 and not at 16 (SECONDS, MINUTES, HOURS, WEEKDAY, DAYS and MONTHS).

TABLE 24-1: DAY OF WEEK SCHEDULE

Day of Week	
Sunday	0
Monday	1
Tuesday	2
Wednesday	3
Thursday	4
Friday	5
Saturday	6

27.6 Timer2/4 Operation During Sleep

When PSYNC = 1, Timer2/4 cannot be operated while the processor is in Sleep mode. The contents of the TMR2 and T2PR registers will remain unchanged while processor is in Sleep mode.

When PSYNC = 0, Timer2/4 will operate in Sleep as long as the clock source selected is also still running. Selecting the LFINTOSC, MFINTOSC, or HFINTOSC oscillator as the timer clock source will keep the selected oscillator running during Sleep.

28.6.3 GO STATUS

Timer run status is determined by the TS bit of the SMTxSTAT register, and will be delayed in time by synchronizer delays in non-Counter modes.

28.7 Modes of Operation

The modes of operation are summarized in Table 28-2. The following sections provide detailed descriptions, examples of how the modes can be used. Note that all waveforms assume WPOL/SPOL/CPOL = 0. When WPOL/SPOL/CPOL = 1, all SMTSIGx, SMTWINx and SMT clock signals will have a polarity opposite to that indicated. For all modes, the REPEAT bit controls whether the acquisition is repeated or single. When REPEAT = 0 (Single Acquisition mode), the timer will stop incrementing and the SMTxGO bit will be reset upon the completion of an acquisition. Otherwise, the timer will continue and allow for continued acquisitions to overwrite the previous ones until the timer is stopped in software.

28.7.1 TIMER MODE

Timer mode is the simplest mode of operation where the SMTxTMR is used as a 16/24-bit timer. No data acquisition takes place in this mode. The timer increments as long as the SMTxGO bit has been set by software. No SMT window or SMT signal events affect the SMTxGO bit. Everything is synchronized to the SMT clock source. When the timer experiences a period match (SMTxTMR = SMTxPR), SMTxTMR is reset and the period match interrupt trips. See Figure 28-3.

TABLE 28-2: MODES OF OPERATION

MODE	Mode of Operation	Synchronous Operation	Reference
0000	Timer	Yes	**Section 28.7.1 “Timer Mode”**
0001	Gated Timer	Yes	**Section 28.7.2 “Gated Timer Mode”**
0010	Period and Duty Cycle Acquisition	Yes	**Section 28.7.3 “Period and Duty-Cycle Mode”**
0011	High and Low Time Measurement	Yes	**Section 28.7.4 “High and Low-Measure Mode”**
0100	Windowed Measurement	Yes	**Section 28.7.5 “Windowed Measure Mode”**
0101	Gated Windowed Measurement	Yes	**Section 28.7.6 “Gated Window Measure Mode”**
0110	Time of Flight	Yes	**Section 28.7.7 “Time of Flight Measure Mode”**
0111	Capture	Yes	**Section 28.7.8 “Capture Mode”**
1000	Counter	No	**Section 28.7.9 “Counter Mode”**
1001	Gated Counter	No	**Section 28.7.10 “Gated Counter Mode”**
1010	Windowed Counter	No	**Section 28.7.11 “Windowed Counter Mode”**
1011-1111	Reserved	—	—

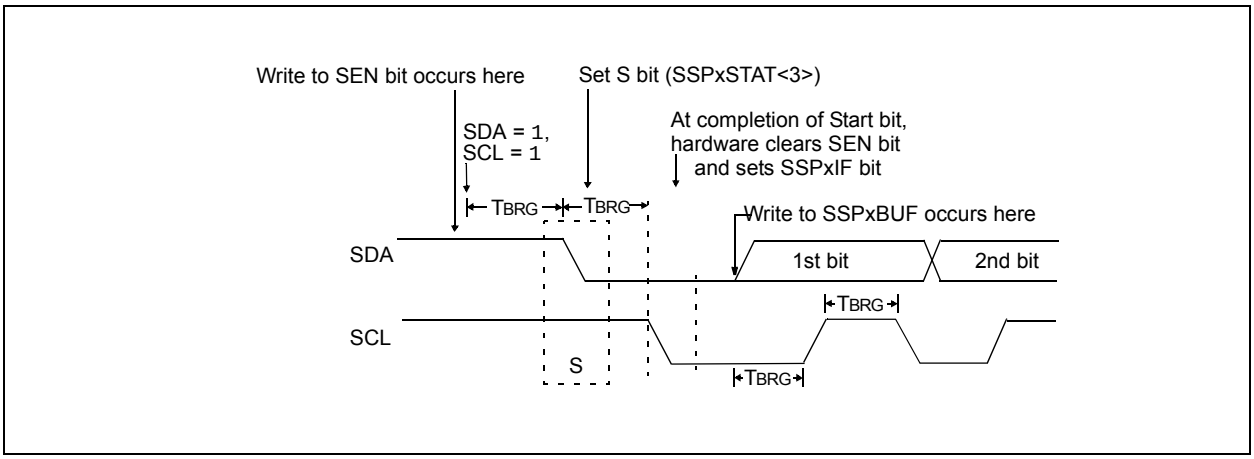
33.6.4 I²C MASTER MODE START CONDITION TIMING

To initiate a Start condition (Figure 33-26), the user sets the Start Enable bit, SEN bit of the SSPxCON2 register. If the SDA and SCL pins are sampled high, the Baud Rate Generator is reloaded with the contents of SSPxADD<7:0> and starts its count. If SCL and SDA are both sampled high when the Baud Rate Generator times out (TBRG), the SDA pin is driven low. The action of the SDA being driven low while SCL is high is the Start condition and causes the S bit of the SSPxSTAT1 register to be set. Following this, the Baud Rate Generator is reloaded with the contents of SSPxADD<7:0> and resumes its count. When the Baud Rate Generator times out (TBRG), the SEN bit of the SSPxCON2 register will be automatically cleared by hardware; the Baud Rate Generator is suspended, leaving the SDA line held low and the Start condition is complete.

Note 1: If at the beginning of the Start condition, the SDA and SCL pins are already sampled low, or if during the Start condition, the SCL line is sampled low before the SDA line is driven low, a bus collision occurs, the Bus Collision Interrupt Flag, BCLIF, is set, the Start condition is aborted and the I²C module is reset into its Idle state.

2: The Philips I²C specification states that a bus collision cannot occur on a Start.

FIGURE 33-26: FIRST START BIT TIMING



34.4 EUSART Synchronous Mode

Synchronous serial communications are typically used in systems with a single master and one or more slaves. The master device contains the necessary circuitry for baud rate generation and supplies the clock for all devices in the system. Slave devices can take advantage of the master clock by eliminating the internal clock generation circuitry.

There are two signal lines in Synchronous mode: a bidirectional data line and a clock line. Slaves use the external clock supplied by the master to shift the serial data into and out of their respective receive and transmit shift registers. Since the data line is bidirectional, synchronous operation is half-duplex only. Half-duplex refers to the fact that master and slave devices can receive and transmit data but not both simultaneously. The EUSART can operate as either a master or slave device.

Start and Stop bits are not used in synchronous transmissions.

34.4.1 SYNCHRONOUS MASTER MODE

The following bits are used to configure the EUSART for synchronous master operation:

- SYNC = 1
- CSRC = 1
- SREN = 0 (for transmit); SREN = 1 (for receive)
- CREN = 0 (for transmit); CREN = 1 (for receive)
- SPEN = 1

Setting the SYNC bit of the TXxSTA register configures the device for synchronous operation. Setting the CSRC bit of the TXxSTA register configures the device as a master. Clearing the SREN and CREN bits of the RCxSTA register ensures that the device is in the Transmit mode, otherwise the device will be configured to receive. Setting the SPEN bit of the RCxSTA register enables the EUSART.

34.4.1.1 Master Clock

Synchronous data transfers use a separate clock line, which is synchronous with the data. A device configured as a master transmits the clock on the TX/CK line. The TX/CK pin output driver is automatically enabled when the EUSART is configured for synchronous transmit or receive operation. Serial data bits change on the leading edge to ensure they are valid at the trailing edge of each clock. One clock cycle is generated for each data bit. Only as many clock cycles are generated as there are data bits.

34.4.1.2 Clock Polarity

A clock polarity option is provided for Microwire compatibility. Clock polarity is selected with the SCKP bit of the BAUDxCON register. Setting the SCKP bit sets the clock Idle state as high. When the SCKP bit is set, the data changes on the falling edge of each clock. Clearing the SCKP bit sets the Idle state as low. When the SCKP bit is cleared, the data changes on the rising edge of each clock.

34.4.1.3 Synchronous Master Transmission

Data is transferred out of the device on the RX/DT pin. The RX/DT and TX/CK pin output drivers are automatically enabled when the EUSART is configured for synchronous master transmit operation.

A transmission is initiated by writing a character to the TXxREG register. If the TSR still contains all or part of a previous character the new character data is held in the TXxREG until the last bit of the previous character has been transmitted. If this is the first character, or the previous character has been completely flushed from the TSR, the data in the TXxREG is immediately transferred to the TSR. The transmission of the character commences immediately following the transfer of the data to the TSR from the TXxREG.

Each data bit changes on the leading edge of the master clock and remains valid until the subsequent leading clock edge.

Note:	The TSR register is not mapped in data memory, so it is not available to the user.

34.4.1.4 Synchronous Master Transmission Set-up:

1. Initialize the SPxBRGH, SPxBRGL register pair and the BRGH and BRG16 bits to achieve the desired baud rate (see **Section 34.3 “EUSART Baud Rate Generator (BRG)”**).
2. Enable the synchronous master serial port by setting bits SYNC, SPEN and CSRC.
3. Disable Receive mode by clearing bits SREN and CREN.
4. Enable Transmit mode by setting the TXEN bit.
5. If 9-bit transmission is desired, set the TX9 bit.
6. If interrupts are desired, set the TXxIE bit of the PIE3 register and the GIE and PEIE bits of the INTCON register.
7. If 9-bit transmission is selected, the ninth bit should be loaded in the TX9D bit.
8. Start transmission by loading data to the TXxREG register.

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